

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HUA-MIN CHEN	06/05/2017
MIN WU	06/05/2017
FEIFEI SUN	06/06/2017
TAO CHEN	06/05/2017
RECEIVING PARTY DATA	
Name:	MEDIATEK SINGAPORE PTE. LTD.
Street Address:	NO. 1 FUSIONOPOLIS WALK, #03-01 SOLARIS
City:	SINGAPORE
State/Country:	SINGAPORE
Postal Code:	138628
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15806442
CORRESPONDENCE DATA	
Fax Number:	(925)835-5804
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	408 896 6196
Email:	zheng@imperiumpw.com
Correspondent Name:	LAW OFFICE OF ZHENG JIN
Address Line 1:	P.O.BOX 731450
Address Line 4:	SAN JOSE, CALIFORNIA 95173
ATTORNEY DOCKET NUMBER:	MDT-279
NAME OF SUBMITTER:	ZHENG JIN
SIGNATURE:	/zheng jin/
DATE SIGNED:	11/08/2017
Total Attachments: 3	
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source=MDT-279-Assignment#page3.tif	

ASSIGNMENT OF PATENT APPLICATION

WHEREAS, we, Hua-Min Chen, Min Wu, Feifei Sun, and Tao Chen (hereinafter referred to as ASSIGNORS), having post office addresses of Room 1-1709, Building 602, Beiyuan Road 5th, Chaoyang Dist., Beijing 100012, China; Room 1312, Building No 208, North Shaoyaoju Lane, Chaoyang Dist., Beijing 100029, China; Room 1303, No.35 Beitapingzhuang Road, Haidian District, Beijing 100088, China; No. 14, Chaoyangmen south St., Chaoyang Dist., Beijing 100020, China; respectively, are the joint inventors of the invention described and claimed in the specification forming part of the United States patent application entitled "METHOD AND APPARATUS OF ENHANCED PAGING," executed herewith;

WHEREAS, MEDIATEK Singapore Pte. Ltd. (hereafter referred to as ASSIGNEE), a corporation organized under the laws of Singapore and having a place of business at No. 1 Fusionopolis Walk, #03-01 Solaris, Singapore 138628, is desirous of acquiring the entire right, title, and interest in and to the invention and in and to any letters patents that may be granted thereof in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS hereby sell, assign, and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said invention, said application and any and all letters patents which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues, and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty, or otherwise, said invention, application and all letters patents on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors or assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer, and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patents on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patents on said invention, for litigation regarding said letters patents, or for the purpose of protecting title to said invention or letters patents therefor.

IN WITNESS WHEREOF, We have hereunto signed our names on the day and year set forth below.

<u>Hua-Min Chen</u>	<u>Hua-Min Chen</u>	<u>2007.06.05</u>
Inventor's Signature	Inventor's Printed Name	Date
<u>Min Wu</u>	<u>Min Wu</u>	<u></u>
Inventor's Signature	Inventor's Printed Name	Date
<u>Feifei Sun</u>	<u>Feifei Sun</u>	<u></u>
Inventor's Signature	Inventor's Printed Name	Date
<u>Tao Chen</u>	<u>Tao Chen</u>	<u></u>
Inventor's Signature	Inventor's Printed Name	Date

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NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS hereby sell, assign, and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said invention, and application and any and all letters patents which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues, and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty, or otherwise, said invention, application and all letters patents on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors an assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer, and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patents on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patents on said invention, for litigation regarding said letters patents, or for the purpose of protecting title to said invention or letters patents therefor.

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..... Inventor's Signature	Hua-Min Chen Inventor's Printed Name	 Date
<u>Min Wu</u> Inventor's Signature	Min Wu Inventor's Printed Name	05.06.2017 Date
..... Inventor's Signature	Feifei Sun Inventor's Printed Name	 Date
<u>Tao Chen</u> Inventor's Signature	Tao Chen Inventor's Printed Name	05.06.2017 Date

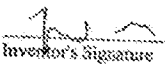
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..... Inventor's Signature	Min Wu Inventor's Printed Name	 Date
 Inventor's Signature	Feifei Sun Inventor's Printed Name	2017-5-6 Date
..... Inventor's Signature	Tao Chen Inventor's Printed Name	 Date